

# RJK0302DPB

Silicon N Channel Power MOS FET Power Switching

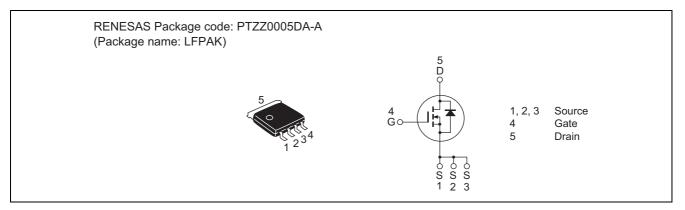
REJ03G1340-0600 Rev.6.00 Apr 19, 2006

### Features

- High speed switching
- Capable of 4.5 V gate drive
- Low drive current
- High density mounting
- Low on-resistance

 $R_{DS(on)} = 2.6 \text{ m}\Omega \text{ typ.} (at V_{GS} = 10 \text{ V})$ 

### Outline



### **Absolute Maximum Ratings**

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	30	V
Gate to source voltage	V <sub>GSS</sub>	+16/-12	V
Drain current	I <sub>D</sub>	50	A
Drain peak current	Note1 I <sub>D(pulse)</sub>	200	A
Body-drain diode reverse drain current	I <sub>DR</sub>	50	A
Avalanche current	I <sub>AP</sub> Note 2	20	A
Avalanche energy	E <sub>AR</sub> Note 2	40	mJ
Channel dissipation	Pch Note3	60	W
Channel to Case Thermal Resistance	θch-C	2.09	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW  $\leq$  10 µs, duty cycle  $\leq$  1%

2. Value at Tch =  $25^{\circ}$ C, Rg  $\geq 50 \Omega$ 

3. Tc = 25°C

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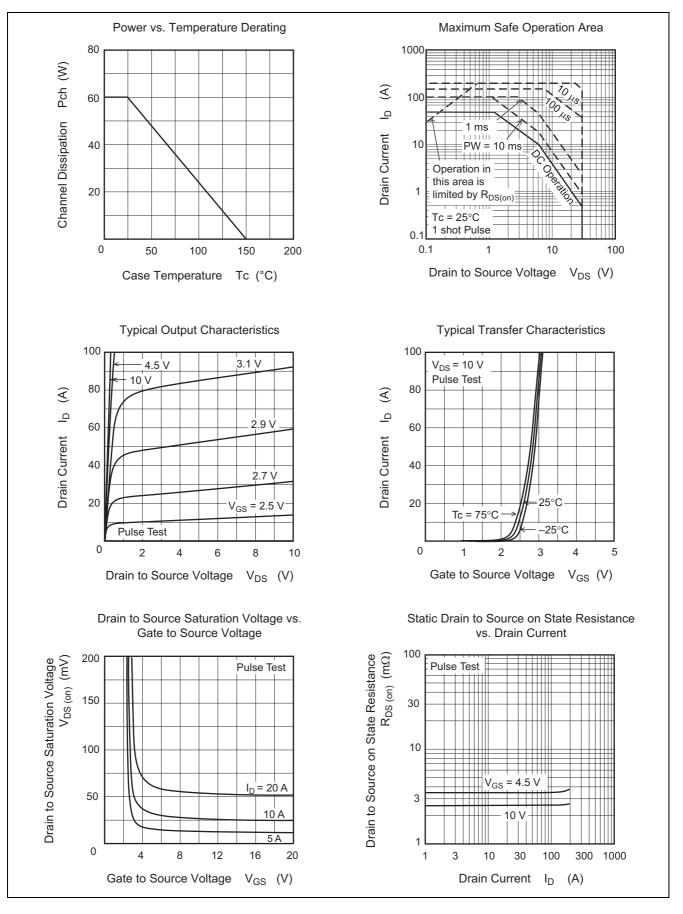
## **Electrical Characteristics**

Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V <sub>(BR)DSS</sub>	30	_	_	V	$I_{D} = 10 \text{ mA}, V_{GS} = 0$
Gate to source leak current	I <sub>GSS</sub>	—	—	± 0.1	μA	$V_{GS} = +16/-12 \text{ V}, \text{ V}_{DS} = 0$
Zero gate voltage drain current	I <sub>DSS</sub>		—	1	μA	$V_{DS} = 30 V, V_{GS} = 0$
Gate to source cutoff voltage	V <sub>GS(off)</sub>	1.2	—	2.5	V	$V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$
Static drain to source on state	R <sub>DS(on)</sub>	_	2.6	3.1	mΩ	$I_D = 25 \text{ A}, V_{GS} = 10 \text{ V}^{Note4}$
resistance	R <sub>DS(on)</sub>	_	3.5	4.6	mΩ	$I_D = 25 \text{ A}, V_{GS} = 4.5 \text{ V}^{\text{Note4}}$
Forward transfer admittance	y <sub>fs</sub>	_	95	_	S	$I_D = 25 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$
Input capacitance	Ciss	_	4200	_	pF	$V_{DS} = 10 V, V_{GS} = 0,$ f = 1 MHz
Output capacitance	Coss	_	1380	_	pF	
Reverse transfer capacitance	Crss	_	210	_	pF	
Gate Resistance	Rg	_	0.7	—	Ω	
Total gate charge	Qg	_	28	—	nC	$V_{DD} = 10 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V},$ $I_D = 50 \text{ A}$
Gate to source charge	Qgs	_	12	—	nC	
Gate to drain charge	Qgd	_	6.0	—	nC	
Turn-on delay time	t <sub>d(on)</sub>	_	11	—	ns	
Rise time	tr	_	4.0	—	ns	
Turn-off delay time	t <sub>d(off)</sub>	_	54	—	ns	
Fall time	t <sub>f</sub>	_	5.5	—	ns	
Body-drain diode forward voltage	V <sub>DF</sub>		0.84	1.10	V	$IF = 50 A, V_{GS} = 0^{Note4}$
Body-drain diode reverse recovery	t <sub>rr</sub>		40	—	ns	IF = 50 A, V <sub>GS</sub> = 0
time						$di_F/dt = 100 \text{ A}/\mu \text{s}$

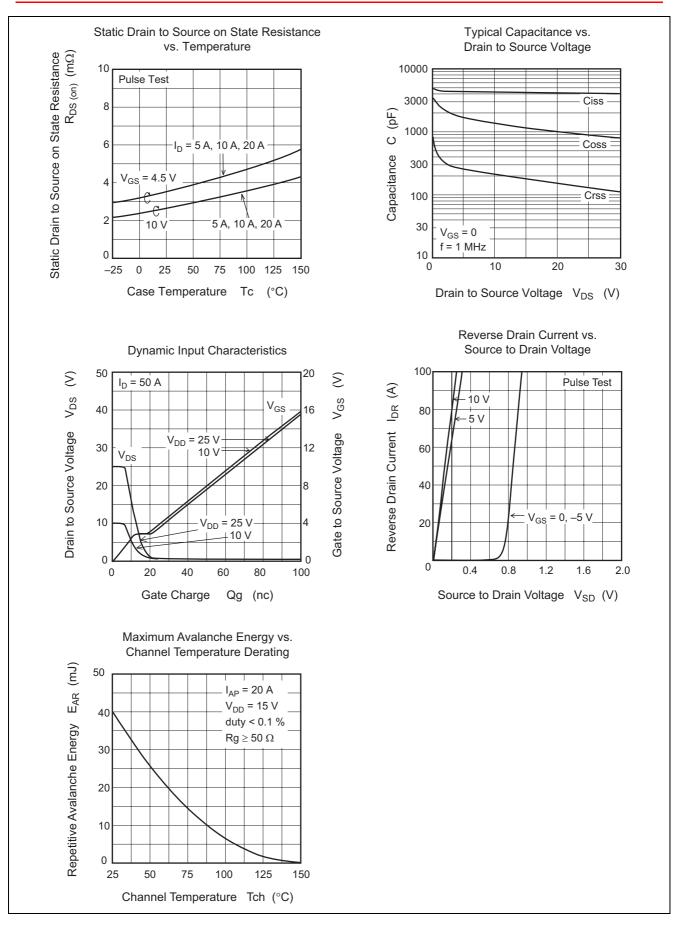
Notes: 4. Pulse test



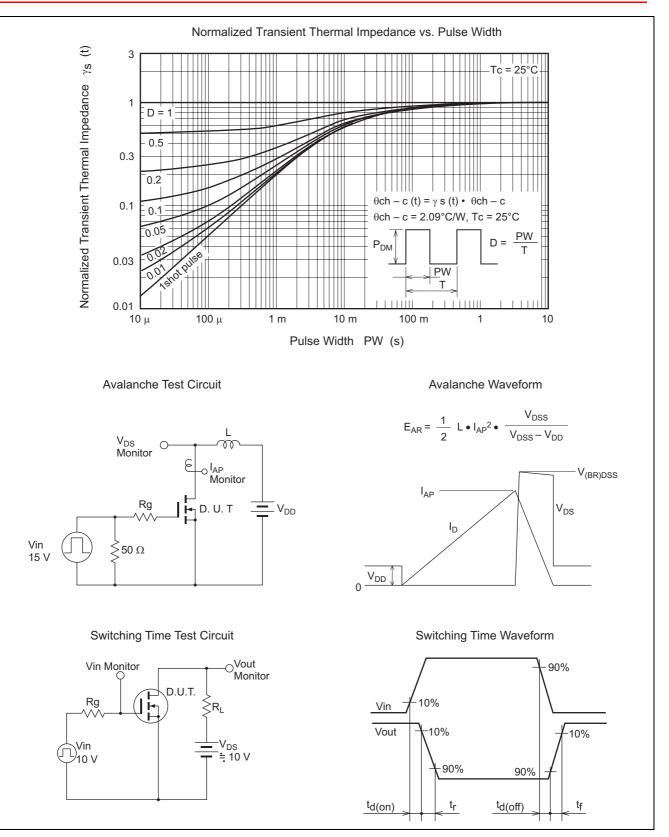
### **Main Characteristics**





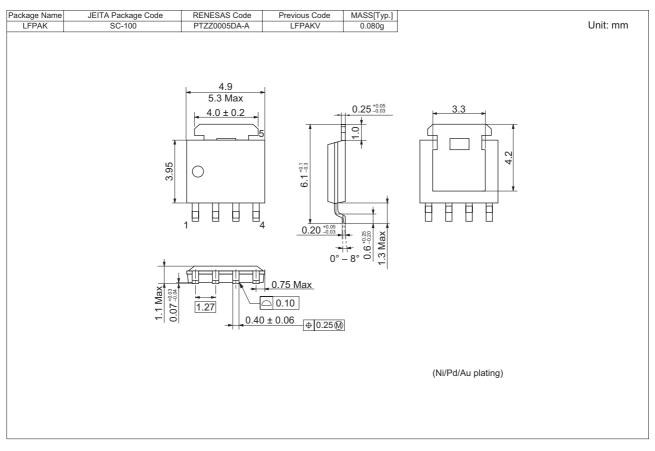








### **Package Dimensions**



### **Ordering Information**

Part Name	Quantity	Shipping Container
RJK0302DPB-00-J0	2500 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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